Product data sheet

1. General description

Quad high-speed switching diodes with common anode configurations encapsulated in a leadless ultra small DFN1412-6 (SOT1268) Surface-Mounted Device (SMD) plastic package.

2. Features and benefits

- High switching speed: t_{rr} ≤ 4 ns
- Low leakage current
- Reverse voltage V_R ≤ 90 V
- Low capacitance C_d ≤ 2 pF
- Ultra small SMD plastic package
- AEC-Q101 qualified

3. Applications

- · High-speed switching
- General-purpose switching

4. Quick reference data

Table 1. Quick reference data

| Symbol | Parameter | Conditions | | Min | Тур | Max | Unit |
|-----------------|-----------------------|--|-----|-----|-----|------|------|
| Per diode | | | | | | | |
| I _F | forward current | single diode loaded; T _{amb} = 25 °C | [1] | - | - | 375 | mA |
| I _R | reverse current | V _R = 80 V; pulsed; T _j = 25 °C | | - | - | 0.5 | μΑ |
| V _F | forward voltage | I_F = 150 mA; $t_p \le 300$ μs; $δ \le 0.02$; T_j = 25 °C | | - | - | 1.25 | V |
| V _R | reverse voltage | T _j = 25 °C | | - | - | 90 | V |
| t _{rr} | reverse recovery time | I_F = 10 mA; I_R = 10 mA; R_L = 100 Ω; $I_{R(meas)}$ = 1 mA; T_{amb} = 25 °C | | - | - | 4 | ns |

[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.



Quad high-speed switching diodes

5. Pinning information

Table 2. Pinning information

| Pin | Symbol | Description | Simplified outline | Graphic symbol |
|-----|--------|--------------------------|------------------------|----------------|
| 1 | K1 | cathode (diode 1) | | |
| 2 | K2 | cathode (diode 2) | 7 6 | K1 A1,2 |
| 3 | A3,4 | com. anode (diodes 3, 4) | 2 5 | K2 K4 |
| 4 | K3 | cathode (diode 3) | | A3,4 K3 |
| 5 | K4 | cathode (diode 4) | 3 8 4 | |
| 6 | A1,2 | com. anode (diodes 1, 2) | | aaa-026796 |
| 7 | A1,2 | com. anode (diodes 1, 2) | Transparent top view | |
| 8 | A3,4 | com. anode (diodes 3, 4) | DFN1412-6 (SOT1268) | |

6. Ordering information

Table 3. Ordering information

| Type number | Package | | | | | |
|-------------|-----------|---|---------|--|--|--|
| | Name | Description | Version | | | |
| BAW56SRA | DFN1412-6 | plastic, thermal enhanced ultra thin small outline package; no leads; 6 terminals; 1.4 mm x 1.2 mm x 0.47 mm body | SOT1268 | | | |

7. Marking

Table 4. Marking codes

| Type number | Marking code |
|-------------|--------------|
| BAW56SRA | A2 |

Quad high-speed switching diodes

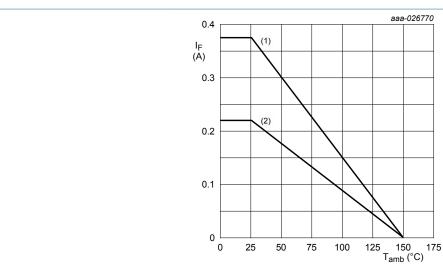
8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

| Symbol | Parameter | Conditions | | Min | Max | Unit |
|------------------|---------------------------------|---|-----|----------|-----|------|
| Per diode | | | _ | <u> </u> | | |
| V _R | reverse voltage | T _j = 25 °C | | - | 90 | V |
| I _F | forward current | single diode loaded; T _{amb} = 25 °C | [1] | - | 375 | mA |
| | | double diodes loaded; T _{amb} = 25 °C | [1] | - | 220 | mA |
| I _{FSM} | non-repetitive peak | t_p = 100 μ s; $T_{j(init)}$ = 25 °C; square wave | | - | 4 | Α |
| | forward current | t_p = 1 ms; $T_{j(init)}$ = 25 °C; square wave | | - | 1.5 | Α |
| | | t_p = 1 s; $T_{j(init)}$ = 25 °C; square wave | | - | 0.5 | А |
| I _{FRM} | repetitive peak forward current | $t_p \le 0.5 \text{ ms}; \delta \le 0.25$ | | - | 1 | А |
| Per device; o | ne diode loaded | | | | | |
| P _{tot} | total power dissipation | T _{amb} ≤ 25 °C | [1] | - | 410 | mW |
| | | | [2] | - | 610 | mW |
| Tj | junction temperature | | | - | 150 | °C |
| T _{amb} | ambient temperature | | | -55 | 150 | °C |
| T _{stg} | storage temperature | | | -65 | 150 | °C |

- [1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.
- [2] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated mounting pad for cathode 1cm².



- (1) single diode loaded
- (2) double diode loaded

Fig. 1. Forward current as a function of ambient temperature; derating curve

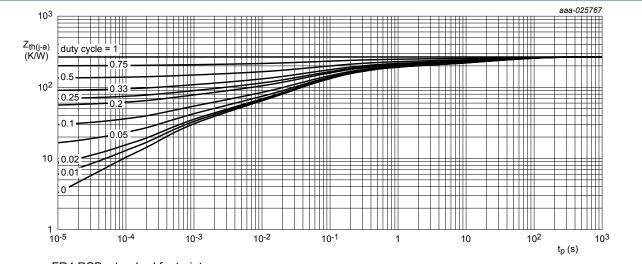
Quad high-speed switching diodes

9. Thermal characteristics

Table 6. Thermal characteristics

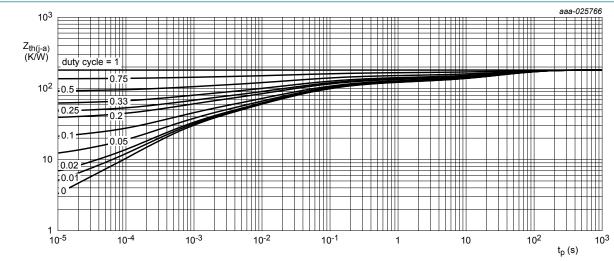
| Symbol | Parameter | Conditions | | Min | Тур | Max | Unit |
|----------------------|--|-------------|-----|-----|-----|-----|------|
| R _{th(j-a)} | thermal resistance from | in free air | [1] | - | - | 305 | K/W |
| jun | junction to ambient | | [2] | - | - | 205 | K/W |
| $R_{th(j-sp)}$ | thermal resistance from junction to solder point | | [3] | - | - | 40 | K/W |

- Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.
- [2] [3] Device mounted on an FR4 PCB, single-sided copper, tin-plated mounting pad for cathode 1cm².
- Soldering point of anode tab.



FR4 PCB, standard footprint

Fig. 2. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values



FR4 PCB, mounting pad for cathode 1 cm²

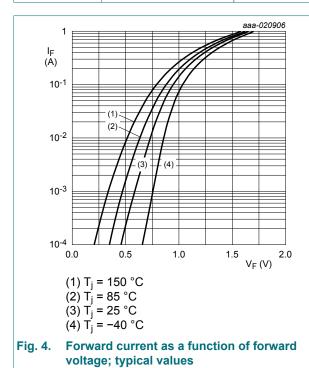
Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

Quad high-speed switching diodes

10. Characteristics

Table 7. Characteristics

| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
|-----------------|-------------------------------|--|-----|-----|------|------|
| Per diode | , | | | | | |
| V _F | forward voltage | I_F = 1 mA; $t_p \le 300$ μs; $δ \le 0.02$; T_j = 25 °C | - | - | 715 | mV |
| | | I_F = 10 mA; $t_p \le 300$ μs; $δ \le 0.02$; T_j = 25 °C | - | - | 855 | mV |
| | | I_F = 50 mA; t_p ≤ 300 μs; δ ≤ 0.02; T_j = 25 °C | - | - | 1 | V |
| | | I_F = 150 mA; $t_p \le 300$ μs; $δ \le 0.02$; T_j = 25 °C | - | - | 1.25 | V |
| I _R | reverse current | V _R = 25 V; pulsed; T _j = 25 °C | - | - | 30 | nA |
| | | V _R = 80 V; pulsed; T _j = 25 °C | - | - | 0.5 | μΑ |
| | | V _R = 25 V; pulsed; T _j = 150 °C | - | - | 30 | μΑ |
| | | V _R = 80 V; pulsed; T _j = 150 °C | - | - | 150 | μΑ |
| C _d | diode capacitance | V _R = 0 V; f = 1 MHz; T _j = 25 °C | - | - | 2 | pF |
| t _{rr} | reverse recovery time | I_F = 10 mA; I_R = 10 mA; R_L = 100 Ω; $I_{R(meas)}$ = 1 mA; I_{amb} = 25 °C | - | - | 4 | ns |
| V_{FRM} | peak forward recovery voltage | $I_F = 10 \text{ mA}; t_r = 20 \text{ ns}$ | - | - | 1.75 | V |



aaa-020907 10⁻³ I_R (A) 10⁻⁴ 10⁻⁵ (2) 10⁻⁶ (3) 10⁻⁷ (4) 10-8 10⁻⁹ (5) 10⁻¹⁰ 10⁻¹¹ 80 100 V_R (V) 20 (1) $T_j = 150 \, ^{\circ}C$ (2) $T_j = 125 ^{\circ}C$ (3) $T_j = 85 ^{\circ}C$ (4) $T_j = 25 ^{\circ}C$ $(5) T_i = -40 ^{\circ}C$

Quad high-speed switching diodes

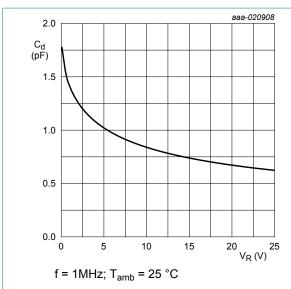
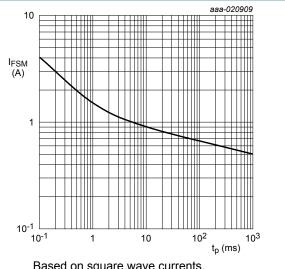


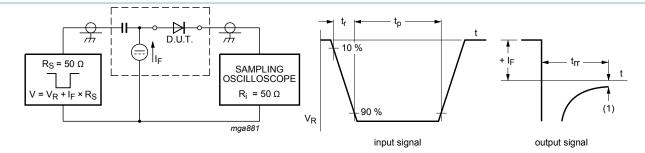
Fig. 6. Diode capacitance as a function of reverse voltage; typical values



Based on square wave currents. T_{amb} = 25 °C

Fig. 7. Non-repetitive forward current as a function of pulse duration; maximum values

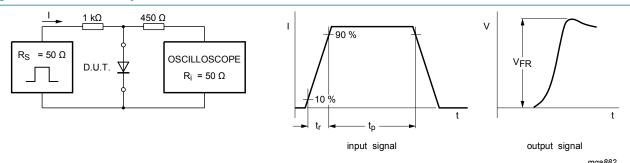
11. Test information



(1) $I_R = 1 \text{ mA}$

Input signal: reverse pulse rise time t_r = 0.6 ns; reverse voltage pulse duration t_p = 100 ns; duty cycle δ = 0.05 Oscilloscope: rise time t_r = 0.35 ns

Fig. 8. Reverse recovery time test circuit and waveforms



Input signal: forward pulse rise time t_r = 20 ns; forward current pulse duration $t_p \ge 100$ ns; duty cycle $\delta \le 0.005$

Fig. 9. Forward recovery voltage test circuit and waveforms

Quality information

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard Q101 - Stress test qualification for discrete semiconductors, and is suitable for use in automotive applications.

BAW56SRA

Quad high-speed switching diodes

12. Package outline

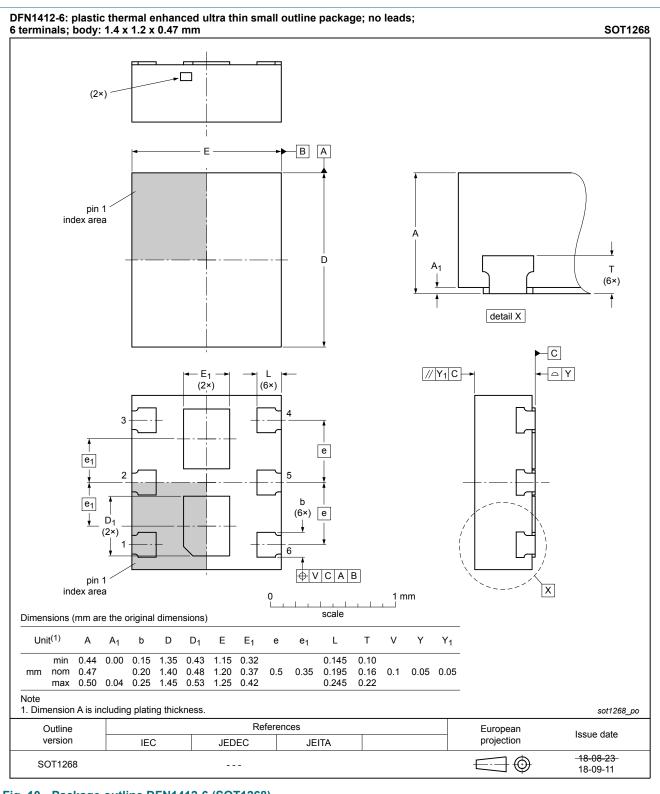
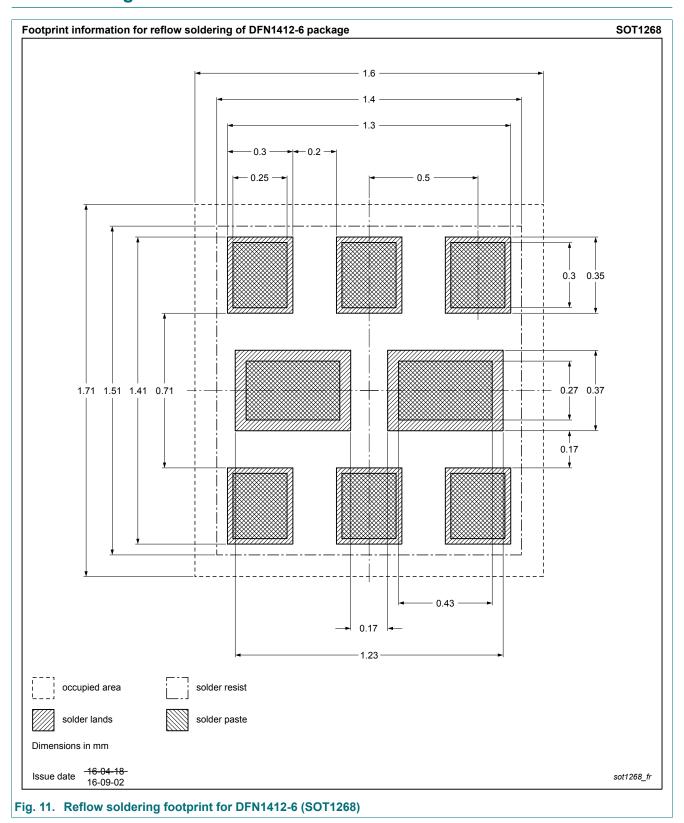


Fig. 10. Package outline DFN1412-6 (SOT1268)

Quad high-speed switching diodes

13. Soldering



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Quad high-speed switching diodes

14. Revision history

Table 8. Revision history

| Table of Notice in Motory | | | | | | | |
|---------------------------|---|--------------------|---------------|--------------|--|--|--|
| Data sheet ID | Release date | Data sheet status | Change notice | Supersedes | | | |
| BAW56SRA v.2 | 20180914 | Product data sheet | - | BAW56SRA v.1 | | | |
| | Package outline drawing updated: Unit T added | | | | | | |
| BAW56SRA v.1 | 20170626 | Product data sheet | - | - | | | |

Quad high-speed switching diodes

15. Legal information

Data sheet status

| Document status [1][2] | Product status [3] | Definition |
|--------------------------------|-----------------------|---|
| Objective [short] data sheet | Development | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet | Qualification | This document contains data from the preliminary specification. |
| Product [short] data sheet | Production | This document contains the product specification. |

- Please consult the most recently issued document before initiating or completing a design.
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